

UNITED STATES PATENT AND TRADEMARK OFFICE
CERTIFICATE OF CORRECTION

PATENT NO. : 7,008,861 B2
APPLICATION NO. : 10/733845
DATED : March 7, 2006
INVENTOR(S) : Andrews et al.

Page 1 of 1

It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

Column 13,

Line 50 should read -- has a depth in the substrate of at least about 25 μm . --

Column 15,

Line 13 should read -- d) an isolation trench in the at least one device layer, the --


Line 37 should read -- **49.** The assembly of claim **35** wherein the shaping trench --

Line 40 should read -- **50.** The assembly of claim **35** wherein the shaping trench --

Line 45 should read -- **52.** The assembly of claim **35** wherein the shaping trench --

Signed and Sealed this

Eighth Day of August, 2006

A handwritten signature in black ink, appearing to read "Jon W. Dudas". The signature is stylized with a large, looped initial "J" and a distinct "D".

JON W. DUDAS
Director of the United States Patent and Trademark Office